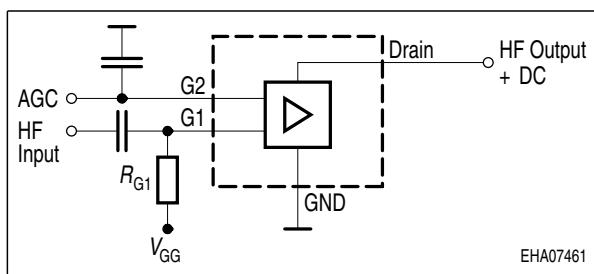
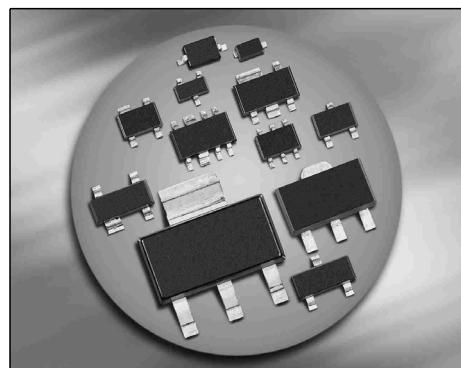


Silicon N-Channel MOSFET Tetrode

- For low noise, high gain controlled input stages up to 1GHz
- Operating voltage 5V



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Class 2 (2000V - 4000V) pin to pin Human Body Model

| Type | Package | Pin Configuration | | | | | | Marking |
|---------|---------|-------------------|-----|------|------|---|---|---------|
| BF2030 | SOT143 | 1= S | 2=D | 3=G2 | 4=G1 | - | - | NDs |
| BF2030R | SOT143R | 1= D | 2=S | 3=G1 | 4=G2 | - | - | NDs |
| BF2030W | SOT343 | 1= D | 2=S | 3=G1 | 4=G2 | - | - | ND |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Drain-source voltage | V_{DS} | 8 | V |
| Continuous drain current | I_D | 20 | mA |
| Gate 1/ gate 2-source current | $\pm I_{G1/2SM}$ | 10 | |
| Gate 1 (external biasing) | $+V_{G1SE}$ | 6 | V |
| Total power dissipation $T_S \leq 76 \text{ }^\circ\text{C}$, BF2030, BF2030R | P_{tot} | 200 | mW |
| $T_S \leq 94 \text{ }^\circ\text{C}$, BF2030W | | 200 | |
| Storage temperature | T_{stg} | -55 ... 150 | °C |
| Channel temperature | T_{ch} | 150 | |

Thermal Resistance

| Parameter | Symbol | Value | Unit |
|---|--------------------|--------------------------|------|
| Channel - soldering point ¹⁾ BF2030/ BF2030R BF2030W | R_{thchs} | ≤ 370 ≤ 280 | K/W |
| | | | |

Electrical Characteristics

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

DC Characteristics

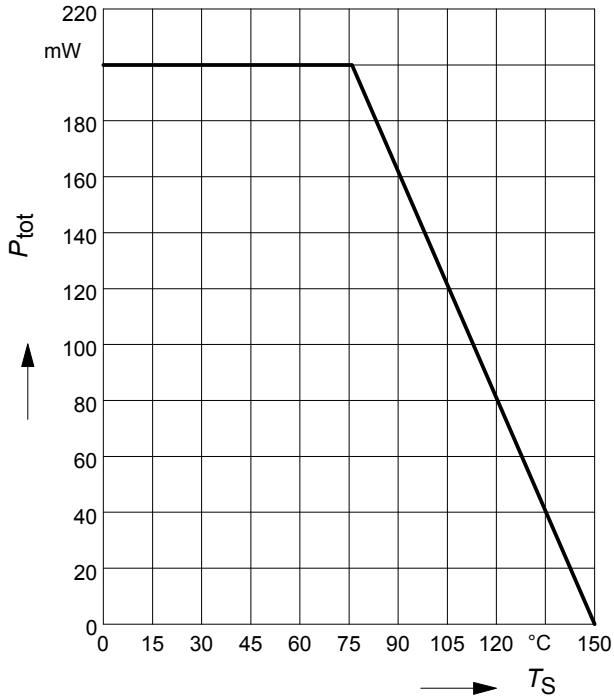
| | | | | | |
|---|------------------------|-----|-----|----|---------------|
| Drain-source breakdown voltage $I_D = 20 \mu\text{A}$, $V_{G1S} = 0$, $V_{G2S} = 0$ | $V_{(\text{BR})DS}$ | 10 | - | - | V |
| Gate1-source breakdown voltage $+I_{G1S} = 10 \text{ mA}$, $V_{G2S} = 0$, $V_{DS} = 0$ | $+V_{(\text{BR})G1SS}$ | 6 | - | 15 | |
| Gate2-source breakdown voltage $+I_{G2S} = 10 \text{ mA}$, $V_{G1S} = 0$, $V_{DS} = 0$ | $+V_{(\text{BR})G2SS}$ | 6 | - | 15 | |
| Gate1-source leakage current $V_{G1S} = 5 \text{ V}$, $V_{G2S} = 0$, $V_{DS} = 0$ | $+I_{G1SS}$ | - | - | 50 | nA |
| Gate2-source leakage current $V_{G2S} = 5 \text{ V}$, $V_{G1S} = 0$, $V_{DS} = 0$ | $+I_{G2SS}$ | - | - | 50 | |
| Drain current $V_{DS} = 5 \text{ V}$, $V_{G1S} = 0$, $V_{G2S} = 4 \text{ V}$ | I_{DSS} | - | - | 50 | μA |
| Drain-source current $V_{DS} = 5 \text{ V}$, $V_{G2S} = 4 \text{ V}$, $R_{G1} = 100 \text{ k}\Omega$ | I_{DSX} | - | 12 | - | mA |
| Gate1-source pinch-off voltage $V_{DS} = 5 \text{ V}$, $V_{G2S} = 4 \text{ V}$, $I_D = 20 \mu\text{A}$ | $V_{G1S(p)}$ | 0.3 | 0.5 | - | V |
| Gate2-source pinch-off voltage $V_{DS} = 5 \text{ V}$, $I_D = 20 \mu\text{A}$ | $V_{G2S(p)}$ | 0.3 | 0.6 | - | |

¹⁾For calculation of R_{thJA} please refer to Application Note Thermal Resistance

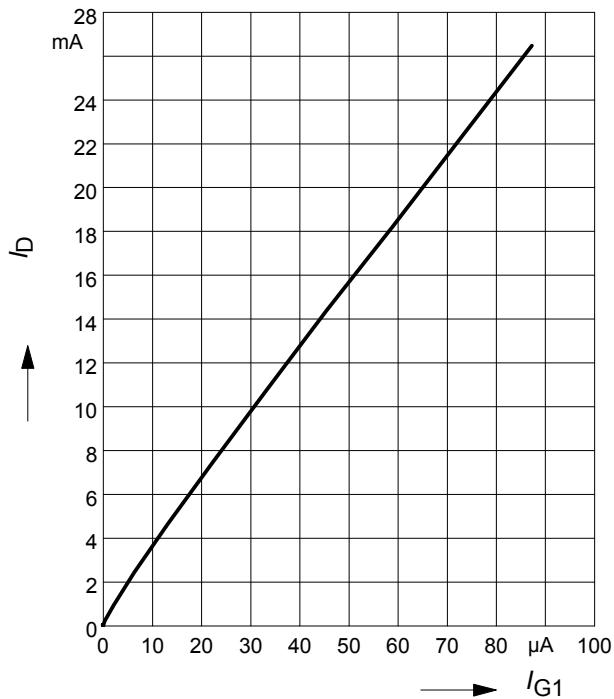
Electrical Characteristics

| Parameter | Symbol | Values | | | Unit |
|--|--------------|--------|------|------|------|
| | | min. | typ. | max. | |
| AC Characteristics (verified by random sampling) | | | | | |
| Forward transconductance $V_{DS} = 5 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$ | g_{fs} | 27 | 31 | - | mS |
| Gate1 input capacitance $V_{DS} = 5 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$, $f = 1 \text{ MHz}$ | C_{g1ss} | - | 2.4 | 2.8 | pF |
| Output capacitance $V_{DS} = 5 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$, $f = 1 \text{ MHz}$ | C_{dss} | - | 1.3 | - | |
| Power gain $V_{DS} = 5 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$, $f = 800 \text{ MHz}$ | G_p | 20 | 23 | - | dB |
| Noise figure $V_{DS} = 5 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$, $f = 800 \text{ MHz}$ | F | - | 1.5 | 2.2 | dB |
| Gain control range $V_{DS} = 5 \text{ V}$, $V_{G2S} = 4\ldots0 \text{ V}$, $f = 800 \text{ MHz}$ | ΔG_p | 40 | 50 | - | |

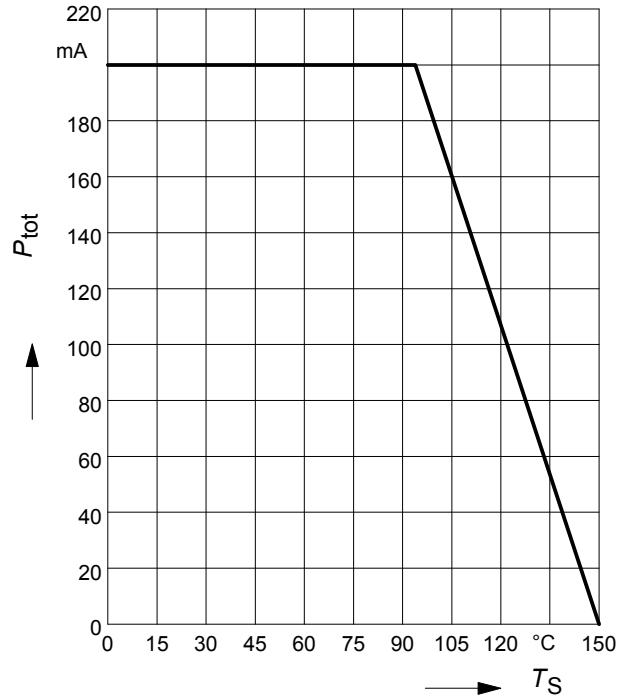
Total power dissipation $P_{\text{tot}} = f(T_S)$
 BF2030, BF2030R



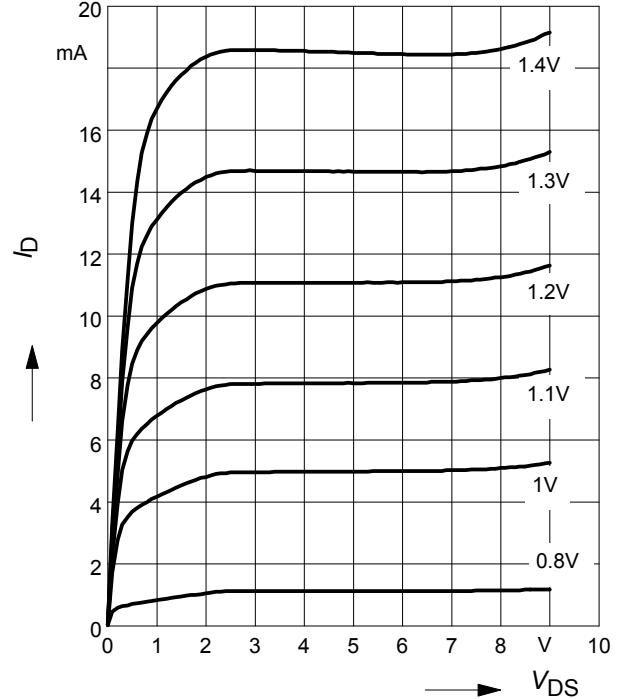
Drain current $I_D = f(I_{G1})$
 $V_{G2S} = 4V$



Total power dissipation $P_{\text{tot}} = f(T_S)$
 BF2030W



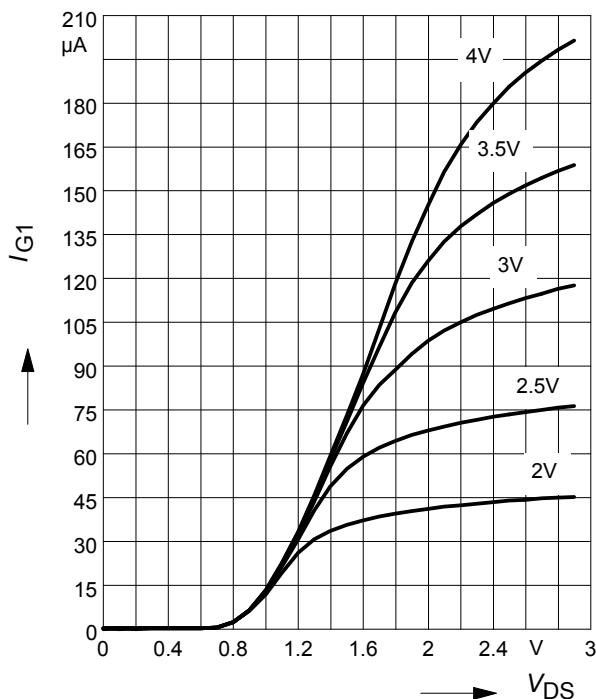
Output characteristics $I_D = f(V_{DS})$
 $V_{G2S} = 4V$
 $V_{G1S} = \text{Parameter}$



Gate 1 current $I_{G1} = f(V_{G1S})$

$V_{DS} = 5V$

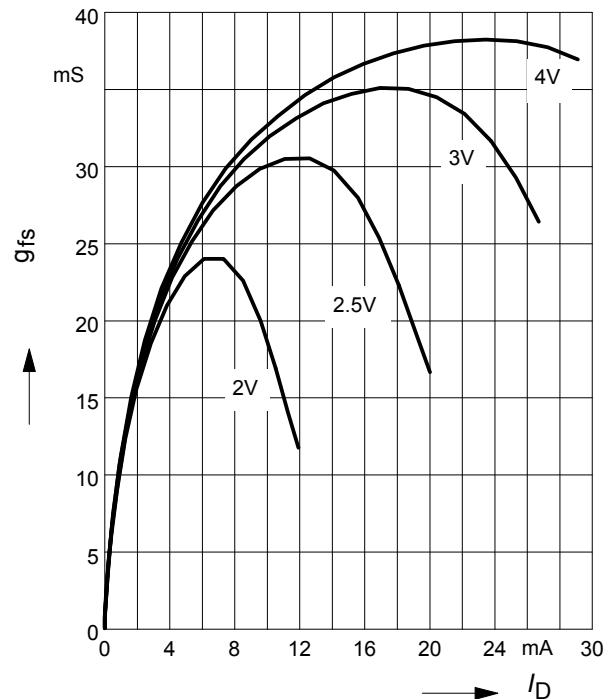
V_{G2S} = Parameter



Gate 1 forward transconductance

$g_{fs} = f(I_D)$

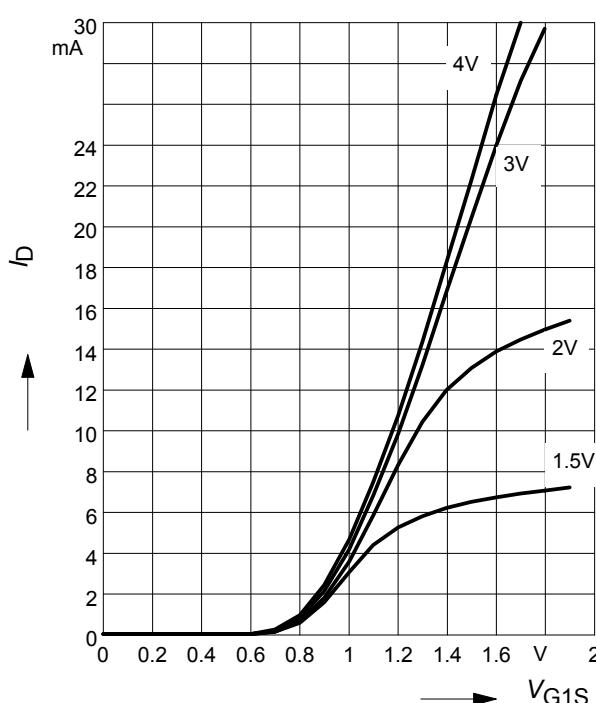
$V_{DS} = 5V, V_{G2S}$ = Parameter



Drain current $I_D = f(V_{G1S})$

$V_{DS} = 5V$

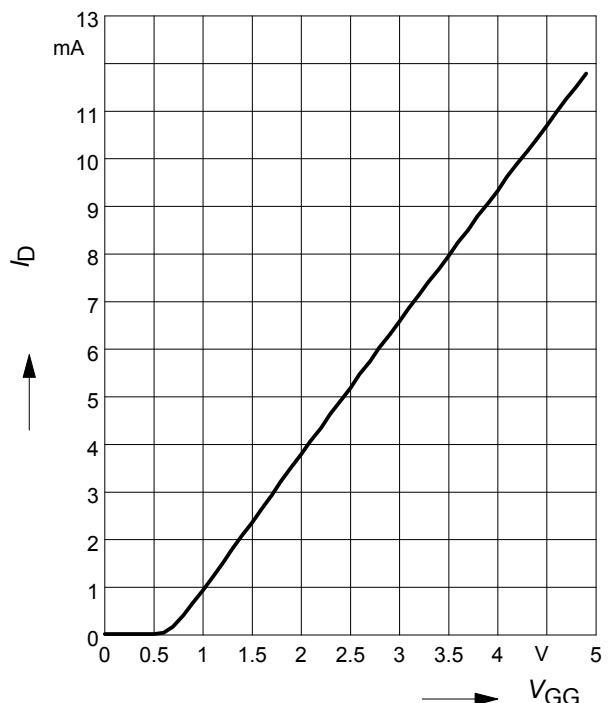
V_{G2S} = Parameter



Drain current $I_D = f(V_{GG})$

$V_{DS} = 5V, V_{G2S} = 4V, R_{G1} = 100k\Omega$

(connected to V_{GG} , V_{GG} =gate1 supply voltage)



Drain current $I_D = f(V_{GG})$

$V_{G2S} = 4V$

R_{G1} = Parameter in $k\Omega$

